



Small Signal Fast Switching Diodes



FEATURES

- Silicon epitaxial planar diode
- Saving space
- Hermetic sealed parts
- Fits onto SOD-323 / SOT-23 footprints
- Electrical data identical with the devices 1N4148 and 1N4448 respectively
- MicroMELF package
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE

ADDITIONAL RESOURCES



MECHANICAL DATA

Case: MicroMELF
Weight: approx. 12 mg
Cathode band color: black
Packaging codes / options:
 TR3/10K per 13" reel (8 mm tape), 10K/box
 TR/2.5K per 7" reel (8 mm tape), 12.5K/box

APPLICATIONS

- Extreme fast switches

PARTS TABLE				
PART	TYPE DIFFERENTIATION	ORDERING CODE	CIRCUIT CONFIGURATION	REMARKS
MCL4148	$V_{RRM} = 100\text{ V}$, V_F at $I_F 50\text{ mA} = 1\text{ V}$	MCL4148-TR3 or MCL4148-TR	Single	Tape and reel
MCL4448	$V_{RRM} = 100\text{ V}$, V_F at $I_F 100\text{ mA} = 1\text{ V}$	MCL4448-TR3 or MCL4448-TR	Single	Tape and reel

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^\circ\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V_R	75	V
Repetitive peak reverse voltage		V_{RRM}	100	V
Peak forward surge current	$t_p = 1\text{ }\mu\text{s}$	I_{FSM}	2	A
Repetitive peak forward current		I_{FRM}	450	mA
Forward continuous current		I_F	200	mA
Average forward current	$V_R = 0\text{ V}$	$I_{F(AV)}$	150	mA
Power dissipation		P_{tot}	500	mW

THERMAL CHARACTERISTICS ($T_{amb} = 25\text{ }^\circ\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Thermal resistance junction to ambient air	Mounted on epoxy-glass hard tissue, Fig. 5, 35 μm copper clad, 0.9 mm ² copper area per electrode	R_{thJA}	500	K/W
Junction temperature		T_j	175	$^\circ\text{C}$
Storage temperature range		T_{stg}	-65 to +175	$^\circ\text{C}$



ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 5\text{ mA}$	MCL4448	V_F	0.620		0.720	V
	$I_F = 50\text{ mA}$	MCL4148	V_F		0.860	1	V
	$I_F = 100\text{ mA}$	MCL4448	V_F		0.930	1	V
Reverse current	$V_R = 20\text{ V}$		I_R			25	nA
	$V_R = 20\text{ V}, T_J = 150\text{ }^{\circ}\text{C}$		I_R			50	μA
	$V_R = 75\text{ V}$		I_R			5	μA
Breakdown voltage	$I_R = 100\text{ }\mu\text{A}, t_p/T = 0.01,$ $t_p = 0.3\text{ ms}$		$V_{(BR)}$	100			V
Diode capacitance	$V_R = 0\text{ V}, f = 1\text{ MHz},$ $V_{HF} = 50\text{ mV}$		C_D			4	pF
Rectification efficiency	$V_{HF} = 2\text{ V}, f = 100\text{ MHz}$		η_r	45			%
Reverse recovery time	$I_F = I_R = 10\text{ mA},$ $i_R = 1\text{ mA}$		t_{rr}			8	ns
	$I_F = 10\text{ mA}, V_R = 6\text{ V},$ $i_R = 0.1 \times I_R, R_L = 100\text{ }\Omega$		t_{rr}			4	

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

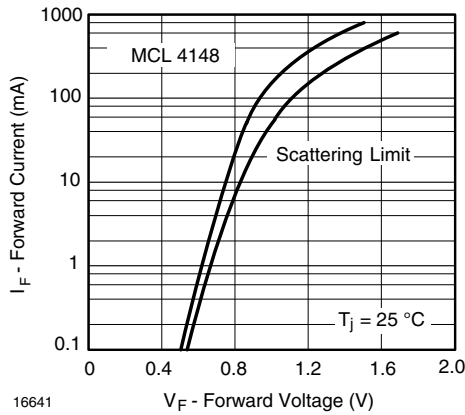


Fig. 1 - Reverse Current vs. Junction Temperature

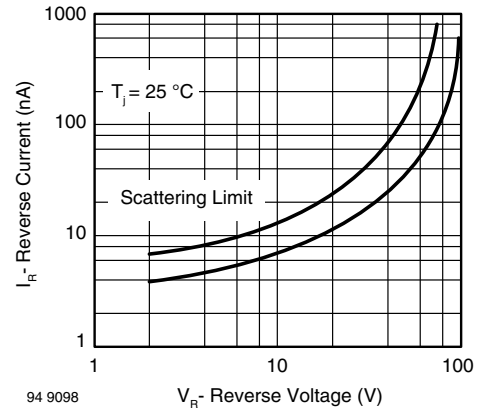


Fig. 3 - Reverse Current vs. Reverse Voltage

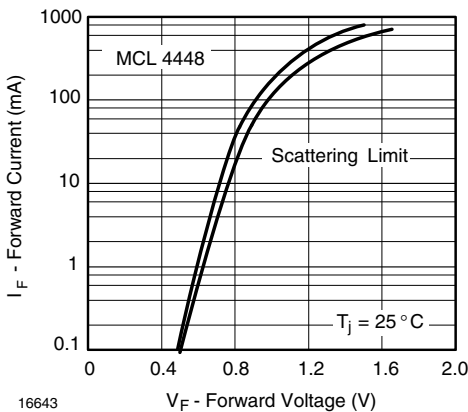


Fig. 2 - Forward Current vs. Forward Voltage

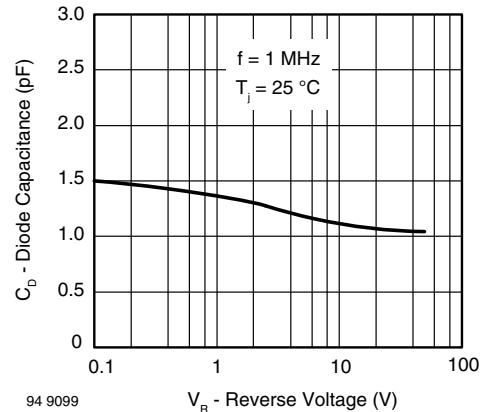


Fig. 4 - Diode Capacitance vs. Reverse Voltage

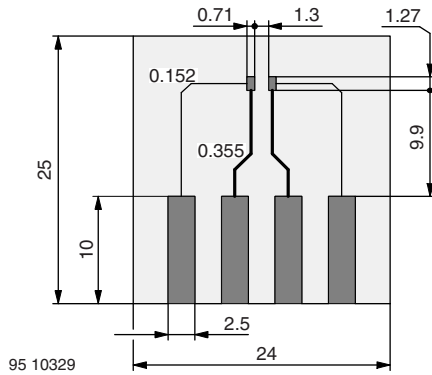
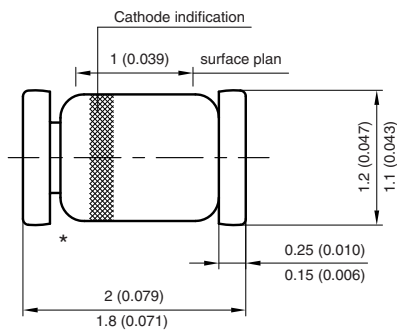
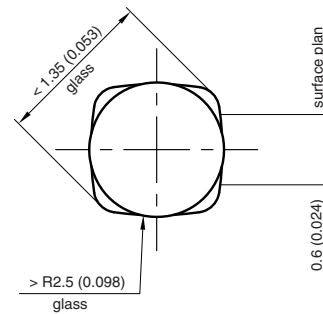


Fig. 5 - Board for R_{thJA} definition (in mm)

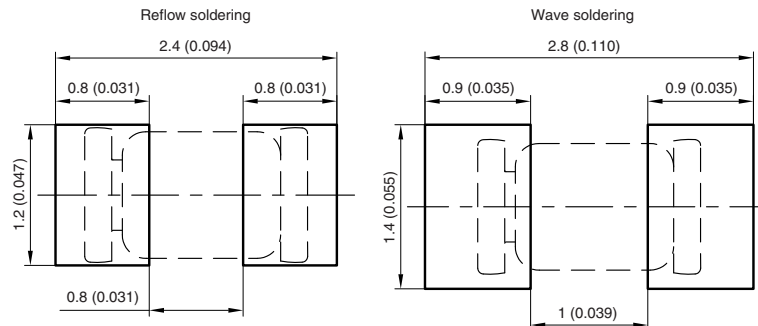
PACKAGE DIMENSIONS in millimeters (inches): **MicroMELF**



* The gap between plug and glass can be either on cathode or anode side



Foot print recommendation:



Created - Date: 26.July.1996
 Rev. 13 - Date: 07.June.2006
 Document no.:6.560-5007.01-4
 96 12072



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